1. MATERIALS: LEAD FRAME, COPPER ALLOY 194 FULL HARD.

2. FINISH: LEAD FRAME ELECTROLESS NICKEL PER MIL-C-26075, CLASS 1, 100 TO 300 MICRONICHES (.25um - 7.6um) THICK.
GOLD PLATE PER MIL-G-45204, TYPE 3, GRADE A, CLASS 1.

3. PACKAGE CONFORMS TO JEDEC MS-012.

GENERAL NOTES: (UNLESS OTHERWISE SPECIFIED)

- UNLESS OTHERWISE SPECIFIED:
  - DIMENSIONS ARE IN INCHES
  - TOLERANCES ARE:
    - FRACTIONAL: ±.001
    - ANGULAR: ±0.5 degree

- PROPORTIONS ARE IN FRACTIONS.
- SEE NOTE 1.
- SEE NOTE 2.

- DRAWN BY: S. Swen
- CHECKED BY: S. Swen
- ENG APPR. BY: S. Swen

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- PROPRIETARY AND CONFIDENTIAL

- 3. PACKAGE CONFORMS TO JEDEC MS-012.

- SOIC, 8 LD, .150 WIDE PACKAGE OUTLINE DRAWING